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FAIRCHILD SEMICONDUCTOR

FDG312P P-Channel 2.5V Specified PowerTrench[™] MOSFET

General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance. These devices are well suited for portable electronics applications.

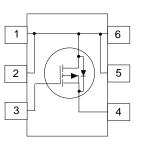
Applications

- Load switch
- Battery protection
- Power management

Features

- -1.2 A, -20 V. $R_{DS(on)} = 0.18 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(on)} = 0.25 \ \Omega \ @ V_{GS} = -2.5 \ V.$
- Low gate charge (3.3 nC typical).
- High performance trench technology for extremely low R_{DS(ON)}.
- Compact industry standard SC70-6 surface mount package.





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		± 8	V
D	Drain Current - Continuous - Pulsed	(Note 1)	-1.2 -6	A
P _D	Power Dissipation for Single Operation	wer Dissipation for Single Operation (Note 1a) 0.75		W
		(Note 1b)	0.55	
		(Note 1c)	0.48	
TJ, T _{stg}	Operating and Storage Junction Temperature Range		55 1 - 450	-0
IJ, Istg	Operating and Storage Junction Tel	mperature Range	-55 to +150	℃
Therma	I Characteristics		-55 to +150	°C
Therma _{R_{θJA} Packag}	I Characteristics Thermal Resistance, Junction-to-Ar	nbient (Note 1)	260	°C/W
Therma R _{θJA} Packag Device	Il Characteristics Thermal Resistance, Junction-to-Ar	nbient (Note 1)		

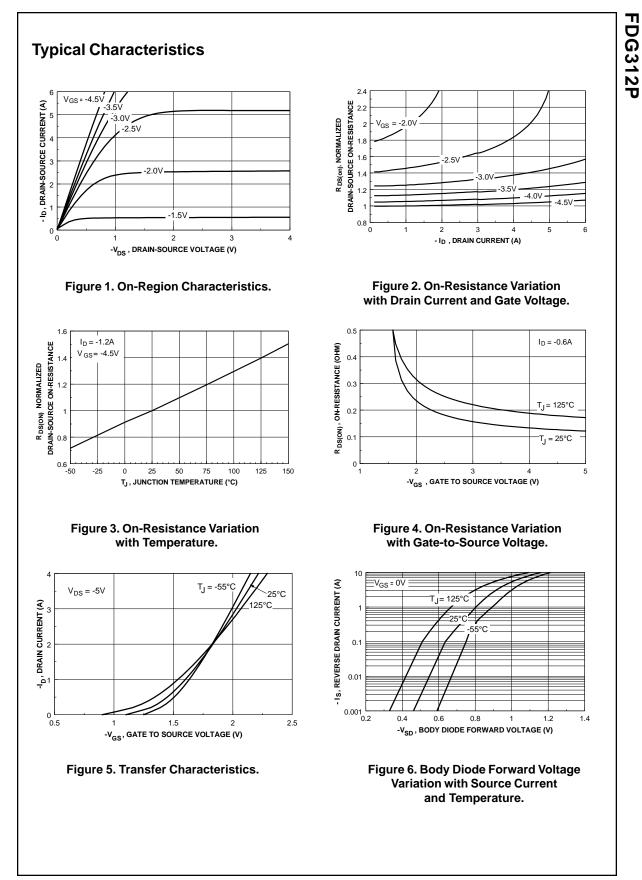
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Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics					•
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-20			V
<u>A</u> BVDSS ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$, Referenced to 25°C		-19		mV/∘C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-0.9	-1.5	V
<u>A</u> VGS(th) ∆TJ	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 _{\text{IL}}\text{A}$, Referenced to 25°C		2.5		mV/∘C
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = -4.5 V, I_D = -1.2 A$ $V_{GS} = -4.5 V, I_D = -1.2 A @ 125 \circ C$ $V_{GS} = -2.5 V, I_D = -1 A$		0.135 0.200 0.187	0.18 0.29 0.25	Ω
D(on)	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	-3			Α
JFS	Forward Transconductance	$V_{DS} = -5 V, I_D = -1.2 A$		3.8		S
Dynamic	Characteristics					
	Input Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$		330		pF
Coss	Output Capacitance	f = 1.0 MHz		80		pF
Crss	Reverse Transfer Capacitance	1		35		pF
0		•	1			
	g Characteristics (Note 2) Turn-On Delay Time	$V_{DD} = -5 V, I_D = -0.5 A,$		7	15	ns
d(on)	Turn-On Rise Time	$V_{\text{GS}} = -4.5 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$		12	22	ns
d(off)	Turn-Off Delay Time	-		16	26	ns
f	Turn-Off Fall Time	-		5	12	ns
Q.	Total Gate Charge	V _{DS} = -10 V, I _D = -1.2 A,		3.3	5	nC
∽ <u>g</u> ⊋ _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		0.8		nC
Q _{qd}	Gate-Drain Charge			0.7		nC
	-	l Marine	I			
brain-50 Is	OURCE Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current				-0.6	A
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = -0.6 \text{ A}$ (Note 2)		-0.83	-1.2	V
Notes: 1. R _{eJA} is the	a) 170°C/W when mounted on a 1 in ² pad of 2oz copper.		lefined as	c) 2 mo	60°C/W w	hen a minimur

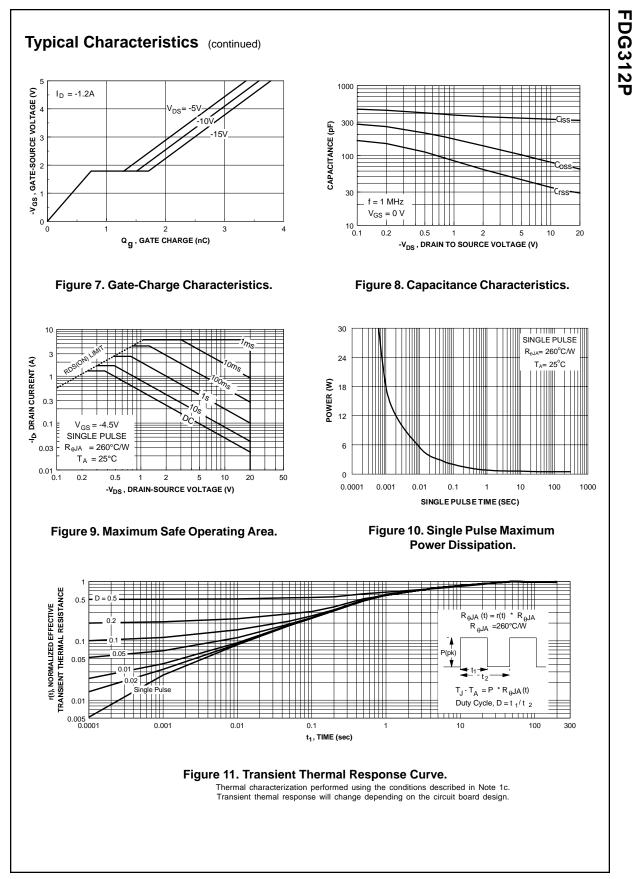
2. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%

FDG312P Rev. C

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